# **One-of-Ten Decoder**

The LSTTL/MSI SN74LS42 is a Multipurpose Decoder designed to accept four BCD inputs and provide ten mutually exclusive outputs. The LS42 is fabricated with the Schottky barrier diode process for high speed and is completely compatible with all ON Semiconductor TTL families.

- Multifunction Capability
- Mutually Exclusive Outputs
- Demultiplexing Capability
- Input Clamp Diodes Limit High Speed Termination Effects



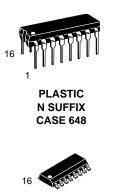
# ON Semiconductor<sup>™</sup>

http://onsemi.com

LOW POWER SCHOTTKY

# **GUARANTEED OPERATING RANGES**

Symbol	Parameter	Min	Тур	Max	Unit
VCC	Supply Voltage	4.75	5.0	5.25	V
TA	Operating Ambient Temperature Range	0	25	70	°C
IОН	Output Current – High			-0.4	mA
IOL	Output Current – Low			8.0	mA



SOIC D SUFFIX CASE 751B



SOEIAJ M SUFFIX CASE 966

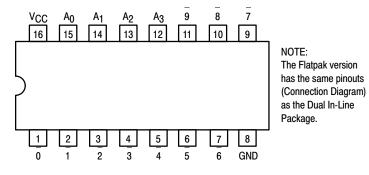
#### ORDERING INFORMATION

Device	Package	Shipping
SN74LS42N	16 Pin DIP	2000 Units/Box
SN74LS42D	SOIC-16	38 Units/Rail
SN74LS42DR2	SOIC-16	2500/Tape & Reel
SN74LS42M	SOEIAJ-16	See Note 1
SN74LS42MEL	SOEIAJ-16	See Note 1

 For ordering information on the EIAJ version of the SOIC package, please contact your local ON Semiconductor representative.

1

#### CONNECTION DIAGRAM DIP (TOP VIEW)

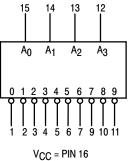


		LOADING	G (Note a)
PIN NAMES		HIGH	LOW
<u>A</u> 0 – <u>A</u> 3 0 to 9	Address Inputs Outputs, Active LOW	0.5 U.L. 10 U.L.	0.25 U.L. 5 U.L.

NOTES:

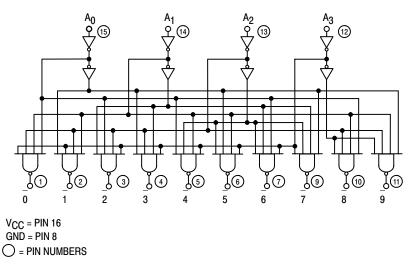
a) 1 TTL Unit Load (U.L.) = 40  $\mu$ A HIGH/1.6 mA LOW.

#### LOGIC SYMBOL



GND = PIN 8





#### **FUNCTIONAL DESCRIPTION**

The LS42 decoder accepts four active HIGH BCD inputs and provides ten mutually exclusive active LOW outputs, as shown by logic symbol or diagram. The active LOW outputs facilitate addressing other MSI units with LOW input enables.

The logic design of the LS42 ensures that all outputs are HIGH when binary codes greater than nine are applied to the inputs.

The most significant input A<sub>3</sub> produces a useful inhibit function when the LS42 is used as a one-of-eight decoder. The A<sub>3</sub> input can also be used as the Data input in an 8-output demultiplexer application.

A <sub>0</sub>	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	0	1	2	3	4	5	6	7	8	9
L	L	L	L	L	Н	Н	Н	Н	Н	Н	Н	Н	Н
н	L	L	L	н	L	н	н	Н	Н	Н	Н	Н	н
L	Н	L	L	н	Н	L	н	Н	Н	Н	Н	Н	н
н	Н	L	L	н	Н	Н	L	Н	Н	Н	н	н	н
L	L	Н	L	н	Н	Н	Н	L	Н	Н	Н	Н	н
н	L	Н	L	н	Н	Н	н	Н	L	Н	н	н	Н
L	Н	Н	L	н	Н	Н	Н	Н	Н	L	Н	Н	н
Н	Н	Н	L	н	Н	Н	Н	Н	Н	Н	L	н	Н
L	L	L	Н	н	Н	Н	Н	Н	Н	Н	Н	L	н
Н	L	L	Н	н	Н	Н	Н	Н	Н	Н	н	н	L
L	Н	L	Н	н	Н	Н	Н	Н	Н	Н	Н	Н	Н
Н	Н	L	Н	н	Н	Н	Н	Н	Н	Н	н	н	Н
L	L	Н	Н	н	Н	Н	Н	Н	Н	Н	Н	Н	н
н	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н
L	Н	Н	Н	н	Н	Н	Н	Н	Н	Н	Н	Н	н
н	Н	Н	Н	н	Н	Н	Н	Н	Н	Н	Н	Н	Н

#### **TRUTH TABLE**

H = HIGH Voltage Level

L = LOW Voltage Level

			Limits				
Symbol	Parameter	Min	Тур	Max	Unit	Test C	onditions
VIH	Input HIGH Voltage	2.0			V	Guaranteed Inpu All Inputs	ut HIGH Voltage for
VIL	Input LOW Voltage			0.8	V	Guaranteed Input LOW Voltage for All Inputs	
VIK	Input Clamp Diode Voltage		-0.65	-1.5	V	$V_{CC} = MIN, I_{IN}$	= –18 mA
VOH	Output HIGH Voltage	2.7	3.5		V	V <sub>CC</sub> = MIN, I <sub>OF</sub> or V <sub>IL</sub> per Truth	<sub>H</sub> = MAX, V <sub>IN</sub> = V <sub>IH</sub> Table
			0.25	0.4	V	I <sub>OL</sub> = 4.0 mA	$V_{CC} = V_{CC} MIN,$
VOL	Output LOW Voltage		0.35	0.5	V	I <sub>OL</sub> = 8.0 mA	VIN = VIL or VIH per Truth Table
				20	μA	V <sub>CC</sub> = MAX, V <sub>II</sub>	N = 2.7 V
IН	Input HIGH Current			0.1	mA	V <sub>CC</sub> = MAX, V <sub>II</sub>	N = 7.0 V
١ <sub>IL</sub>	Input LOW Current			-0.4	mA	$V_{CC} = MAX, V_{IN} = 0.4 V$	
IOS	Short Circuit Current (Note 2)	-20		-100	mA	V <sub>CC</sub> = MAX	
ICC	Power Supply Current			13	mA	$V_{CC} = MAX$	

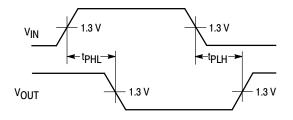
# DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

2. Not more than one output should be shorted at a time, nor for more than 1 second.

# AC CHARACTERISTICS (T<sub>A</sub> = $25^{\circ}$ C)

		Limits					
Symbol	Parameter	Min	Тур	Max	Unit	Tes	t Conditions
<sup>t</sup> PLH <sup>t</sup> PHL	Propagation Delay (2 Levels)		15 15	25 25	ns	Figure 2	V <sub>CC</sub> = 5.0 V
<sup>t</sup> PLH <sup>t</sup> PHL	Propagation Delay (3 Levels)		20 20	30 30	ns	Figure 1	C <sub>L</sub> = 15 pF

#### AC WAVEFORMS



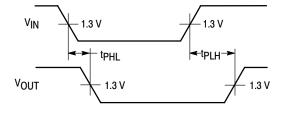
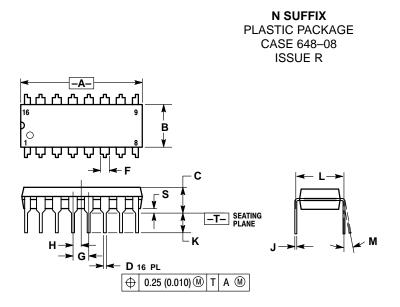


Figure 1.

Figure 2.

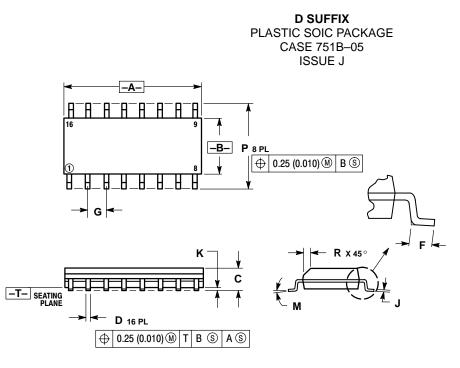
#### PACKAGE DIMENSIONS



- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL. 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH. 5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54	BSC	
н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
К	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
Μ	0 °	10 °	0 °	10 °	
S	0.020	0.040	0.51	1.01	

# PACKAGE DIMENSIONS



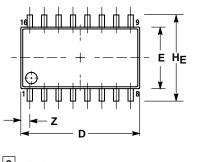
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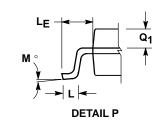
- NOTES:
  DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  CONTROLLING DIMENSION: MILLIMETER.
  DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
  MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
  DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION. SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

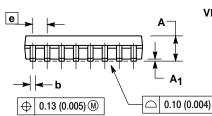
	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	9.80	10.00	0.386	0.393
В	3.80	4.00	0.150	0.157
С	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27	BSC	0.050	BSC
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
М	0 °	7°	0°	7°
Ρ	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

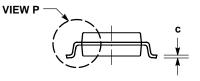
# PACKAGE DIMENSIONS

**M SUFFIX** SOEIAJ PACKAGE CASE 966-01 ISSUE O









NOTES:

- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER. 3. DIMENSIONS D AND E ON TINCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE
- PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
  THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

	MILLIN	IETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α		2.05		0.081	
A <sub>1</sub>	0.05	0.20	0.002	0.008	
b	0.35	0.50	0.014	0.020	
C	0.18	0.27	0.007	0.011	
D	9.90	10.50	0.390	0.413	
Е	5.10	5.45	0.201	0.215	
е	1.27	BSC	0.050	BSC	
Η <sub>E</sub>	7.40	8.20	0.291	0.323	
L	0.50	0.85	0.020	0.033	
LE	1.10	1.50	0.043	0.059	
Μ	0 °	10 °	0 °	10 °	
Q <sub>1</sub>	0.70	0.90	0.028	0.035	
Z		0.78		0.031	

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